

"PATENT"**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Appl. No. : 10/072,575 Confirmation No.: 1933
Applicant : Pang-Chia LU
Filed : February 8, 2002
TC/A.U. : 1773
For : Extruded Multilayer Film Structure Including An Ethylene Acid Terpolymer
Layer For Improved Heat-Seal And Metal Adhesion
Examiner : Kevin R. KRUEER
Docket No. : 2002B004
Customer No. : 23455 Date: August 6, 2003

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MAIL STOP NON-FEE AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT UNDER 37 C.F.R. § 1.111

Sir:

In response to the Office Action mailed May 7, 2003, please amend the above-identified application as follows on the accompanying pages.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 5 of this paper.